

3A Avg.

600 Volts

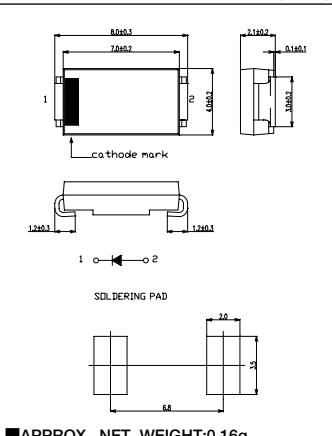
FRED

NSF03E60

■最大定格 Maximum Ratings

Item	Symbol	Conditions			Unit
くり返しピーク逆電圧 Repetitive Peak Reverse Voltage	V _{RRM}	600			V
平均整流電流 Average Rectified Forward Current	I _O	Alumina Substrate mounted*	T _a =25°C*	1.28	A
			50Hz 正弦半波, 抵抗負荷 50Hz Half Sine Wave, Resistance Load	T _j =95°C	3.0
実効順電流 R.M.S. Forward Current	I _{F(RMS)}	4.71			A
サージ順電流 Surge Forward Current	I _{FSM}	60	50Hz 正弦半波, 1サイクル, 非くり返し 50Hz Half Sine Wave, 1cycle, Non-repetitive		A
動作接合温度範囲 Operating Junction Temperature Range	T _{jw}	-40~+150			°C
保存温度範囲 Storage Temperature Range	T _{stg}	-40~+150			°C

■OUTLINE DRAWING(mm)



■APPROX. NET WEIGHT:0.16g

■電気的・熱的特性 Electrical/Thermal Characteristics

Item	Symbol	Conditions		Min.	Typ.	Max.	Unit
ピーグ逆電流 Peak Reverse Current	I _{RM}	T _j =25°C, V _{RRM} =V _{RM}		—	—	20	μA
ピーグ順電圧 Peak Forward Voltage	V _{FM}	T _j =25°C, I _{FM} =3A		—	—	1.28	V
逆回復時間 Reverse Recovery Time	trr	I _{FM} =3A, -di/dt=50 A/μs, T _j =25°C		—	—	75	ns
熱抵抗 Thermal Resistance	R _{th(j-a)}	接合部・周囲間 Junction to Ambient	Alumina Substrate*	—	—	89	°C/W
	R _{th(j-l)}	接合部・リード間 Junction to Lead	—	—	—	13	°C/W

* アルミナ基板実装/Alumina Substrate Mounted (Soldering Lands = 2 × 3.5 mm, Both Sides)

■定格・特性曲線

